

Electronic Acknowledgement Receipt

EFS ID:	1090535
Application Number:	10646952
Confirmation Number:	2987
Title of Invention:	High-viscous moulding materials with nano-scale fillers
First Named Inventor:	Georg Stoppelmann
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Filer:	Robert M. Barrett/Renee Street
Filer Authorized By:	Robert M. Barrett
Attorney Docket Number:	112843-061
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		112843-061amd.pdf	516198	yes	13
Multipart Description					
Doc Desc		Start		End	
Amendment After Final		1		1	
Claims		2		9	
Applicant Arguments/Remarks Made in an Amendment		10		13	

Warnings:**Information:**

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.